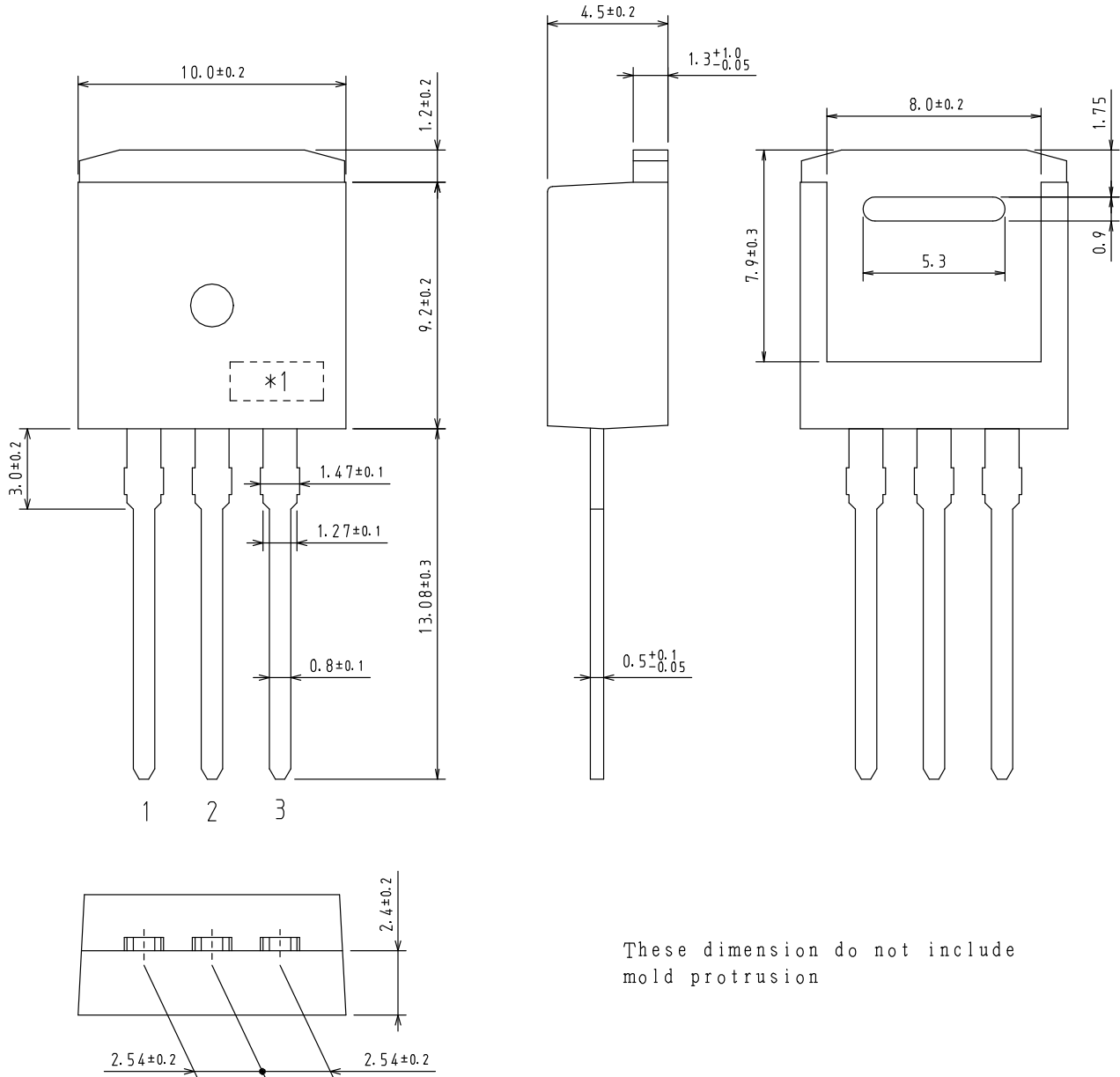


MECHANICAL CASE OUTLINE
PACKAGE DIMENSIONS

I2PAK / TO-262-3L
CASE 418AN
ISSUE 0

DATE 31 MAR 2012



These dimension do not include mold protrusion

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STATUS:	ON SEMICONDUCTOR STANDARD	
NEW STANDARD:		
DESCRIPTION:	I2PAK / TO-262-3L	PAGE 1 OF 2

